

MODEL: TT4761B01-3

Ver.0.1

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Revision History

Version	Date	Page (New)	Section	Description	Revision by
Ver. 0.1	08.May.2013	26	9	Tentative Specification was First Issued.	ZouYingnan



1. General Description

1.1 Product Features

-FHD Resolution (1920 x 1080)

-Very High Contrast Ratio:4000:1

-Fast Response Time

-Ultra Wide Viewing Angle: 178° (H)/178° (V)(CR≥10)

-DE (Data Enable) Mode

-LVDS (Low Voltage Differential Signaling) Interface

1.2 Overview

TT4761B01-3 is a diagonal 47.6" color active matrix LCD open cell with 2ch-LVDS interface. This open cell is atransmissive type display operating in the normally black mode. It supports 1920x1080 FHD resolutions and can display up to 16.7M colors (8bit). Each pixel is divided into Red, Green and Blue sub-pixels which are arranged in vertical stripe.

This open celldedicates for LCD TV products and provides excellent performance which includes high transparency, ultra wide viewing angleand high color depth. CSOT open cell comply with RoHS for identification.

1.3 General Information

Item	Specification	Unit	Note
Active Area	1054.08(H)x592.92(V)	mm	
Cell Size	1068.750(H) x 607.610 (V) x 1.350 (D)	mm	
Weight	2.0	kg	Max.
Driving Scheme	a-Si TFT Active Matrix	-	
Number of Pixels	1920x1080	pixel	
Pixel Pitch (Sub Pixel)	0.183 (H) x 0.549 (V)	mm	
Pixel Arrangement	RGB Vertical Stripe	-	
Display Colors	16.7 M	color	8bit
Display Mode	Transmissive Mode, Normally Black	-	
Glass Thickness (Array/CF)	0.5/0.5	mm	
Color Chromaticity	R=(0.633,0.334) G=(0.322,0.631) B=(0.159,0.049) W=(0.280,0.290)		T
Contrast Ratio	4000:1(Typ.)		Typical value measured at CSOT's module: MT4761B01-1
Cell Transmittance	5.6 % (Typ.)	%	
View Angle(CR>10)	+89/-89(H),+89/-89(V) (Typ.)		
Polarizer(CF side)	Anti-glare, Haze2%, Hard Coating(3H)		
Polarizer(TFT side)	Hard Coating(3H)		

2. Absolute Maximum Ratings

2.1 Absolute Maximum Ratings (T_A = 25 ± 2 °C)

The followings are maximum values which, if exceeded, may cause damage to the unit.

Item	Symbol	Va	Unit	
Heili	Symbol	Min.	Max.	Oiiit
Power Supply Voltage	V_{CC}	-0.3	13.8	V
Input Signal Voltage	V _{IN}	-0.3	4.0	V

2.2 Environment Requirement (Based on CSOT Module MT4761B01-1)

(1) Temperature and relative humidity range are shown as below.

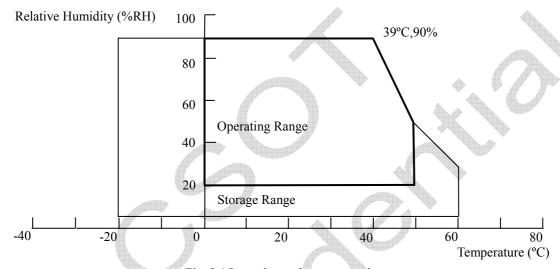


Fig. 2.1Operating and storage environment

- (a) 90%RH maximum ($T_A \le 39$ °C).
- (b) Wet-bulb temperature should be 39°Cmaximum (T_A>39 °C).
- (c) No condensation.
- (2) The storage temperature is between 20 °C to 60 °C, and the operating ambient temperature is between 0 °C to 50 °C. The maximum operating temperature is based on the testcondition that the surface temperature of display area is less than or equal to 65°C with LCD module in a temperature controlled chamber alone. Thermalmanagement should be considered in final product design to prevent the surface temperature of display area from being over 65°C. The range of operating temperature may degrade in case of improper thermal management in the end product design.
- (3) The rating of environment is based on LCD module. Leave LCD cell alone, this environment conditioncan't be guaranteed. Except LCD cell, the customer has to consider the ability of other parts of LCD module and LCD module process.

2.3 Absolute Ratings of Environment (Open Cell)

When storing open cell as spares for a long time, please follow the precaution instructions:

- (1) Do not store the module in high temperature and high humidity for a long time. It is highly recommended to store the module with temperature from 20°C to 30°C in normal humidity (50±10%RH) with shipping package.
- (2) The open cell should be keep within one month shelf life

3. Electrical Specification

3.1 Open Cell Power Consumption (TA = 25 ± 2 °C)

Parameter		Comple of	Value			I Inda	NI-4-
		Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Vo	V _{CC}	10.8	12.0	13.2	V	(1)	
Rush Current		I_{RUSH}	2.0 A		A	(2)	
D C 1	White Pattern	I_{CC}	-	0.38	0.49	A	
Power Supply	Horizontal Stripe	I_{CC}	-	0.78	1.01	A	(3)
Current	Black Pattern	I_{CC}	-	0.34	0.44	A	

Note:

- (1) The ripple voltage should be controlled less than 10% of V_{CC} .
- (2) Measurement condition: $V_{CC}=12V_1$ rising time=470 μ s.

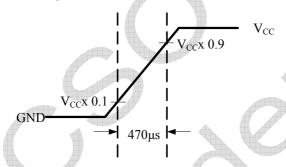


Fig. 3.1 V_{CC} rising time condition

(3)Measurement condition: $V_{CC}=12V$, $T_0=25\pm2^{\circ}C$, F=60 Hz. The test patterns are shown as below.

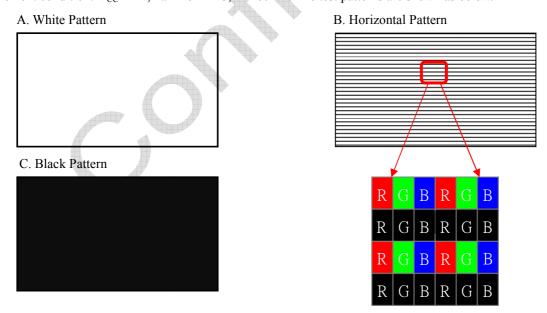


Fig. 3.2 Test patterns

3.2 LVDS Characteristics

Parameter		Symbol		Value	Unit	Note	
		Symbol	Min.	Тур.	Max.	Unit	Note
	Differential Input High Threshold Voltage	V_{TH}	+100	-	-	mV	
LVDS Interface	Differential Input Low Threshold Voltage	V _{TL}	-	-	-100	mV	
	Common Input Voltage	V_{CM}	1.0	1.2	1.4	V	(1)
	Differential Input Voltage	$ V_{ID} $	200	400	600	mV	
	Terminating Resistor	R_{T}	87.5	100	112.5	ohm	
CMOS Interface	Input High Threshold Voltage	V _{IH}	2.7	-	3.3	v	
	Input Low Threshold Voltage	$V_{\rm IL}$	0	-	0.7	V	

Note:

(1) The LVDS input signal has been defined as follows:

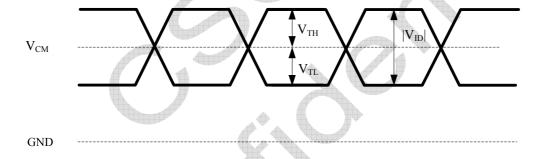


Fig. 3.3 LVDS input signal

4. Input Terminal Pin Assignment

4.1 Interface Pin Assignment

CN1: CT000041-513C (FCN) or equivalent (see Note (1))

Pin No.	Symbol	Description	Note
1	N.C	No Connection	(1)
2	SCL	I2C Serial Clock (for adjust VCOM)	(2)
3	SDA	I2C Serial Data (for adjust VCOM)	
4	N.C	No Connection	(1)
5	I /P O	Output Signal for Left Right Glasses Control	
3	L/R_O	(High: Left Glass turn on Low: Right glass turn on)	
6	N.C.	No Connection	
7	SELLVDS	Input Signal for LVDS Data Format Selection	(3)
/	SELLVDS	(High:VESA Format, Low or Open JEIDA Format)	(3)
8	N.C.	No Connection	(1)
9	N.C.	No Connection	(1)
10	N.C.	No Connection	(1)
11	GND	Ground	
12	ORX0-	Odd Pixel Negative LVDS Differential Data Input. Channel 0	
13	ORX0+	Odd Pixel Positive LVDS Differential Data Input. Channel 0	
14	ORX1-	Odd Pixel Negative LVDS Differential Data Input. Channel 1	
15	ORX1+	Odd Pixel Positive LVDS Differential Data Input. Channel 1	
16	ORX2-	Odd Pixel Negative LVDS Differential Data Input. Channel 2	
17	ORX2+	Odd Pixel Positive LVDS Differential Data Input. Channel 2	
18	GND	Ground	
19	OCLK-	Odd Pixel Negative LVDS Differential Clock Input	
20	OCLK+	Odd Pixel Positive LVDS Differential Clock Input	
21	GND	Ground	
22	ORX3-	Odd Pixel Negative LVDS Differential Data Input. Channel 3	
23	ORX3+	Odd Pixel Positive LVDS Differential Data Input. Channel 3	
24	N.C.	No Connection	(1)
25	N.C.	No Connection	(1)
26	2D/3D	Input Signal for 2D/3D Mode Selection	
20	2D/3D	(High:3D Enable,LOW:3D Disable)	
27	N.C.	No Connection	(1)
28	ERX0-	Even Pixel Negative LVDS Differential Data Input. Channel 0	
29	ERX0+	Even pixel Positive LVDS Differential Data Input. Channel 0	
30	ERX1-	Even Pixel Negative LVDS Differential Data Input. Channel 1	

31	ERX1+	Even Pixel Positive LVDS Differential Data Input. Channel 1
32	ERX2-	Even Pixel Negative LVDS Differential Data Input. Channel 2
33	ERX2+	Even Pixel Positive LVDS Differential Data Input. Channel 2
34	GND	Ground
35	ECLK-	Even Pixel Negative LVDS Differential Clock Input
36	ECLK+	Even Pixel Negative LVDS Differential Clock Input
37	GND	Ground
38	ERX3-	Even Pixel Negative LVDS Differential Data Input. Channel 3
39	ERX3+	Even Pixel Positive LVDS Differential Data Input. Channel 3
40	N.C.	No Connection
41	N.C.	No Connection
42	N.C.	No Connection (1)
43	N.C.	No Connection (1)
44	GND	Ground
45	GND	Ground
46	GND	Ground
47	N.C.	No Connection (1)
48	VCC	+12V Power Supply
49	VCC	+12V Power Supply
50	VCC	+12V Power Supply
51	VCC	+12V Power Supply

Note:

- (1) For CSOT internal only, please let it opens.
- (2) 3D Format: Default line by line.
- (3) High: connect to +3.3V→VESA Format; Low: connect to GND or Open→JEIDA format.
- (4) The first LVDS data is ODD LVDS data
- (5) The direction of pin assignment is shown as below:

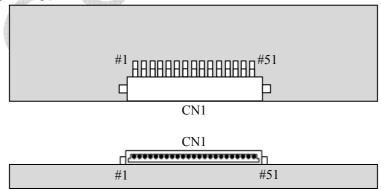


Fig. 4.1 LVDS connector direction sketch map

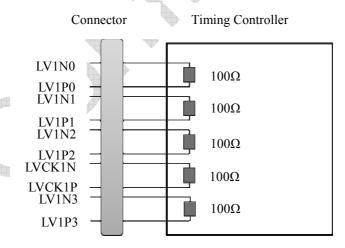
CN1: 0-12002024-5 (XINDAYITONG) or equivalent

	Co	ontrol board		Converter		
Pin NO.	Symbol	Feature		Pin NO.	Symbol	Feature
12	NC			1	NC	
11	NC			2	NC	
10	PDIM	PWM dimming	3	3	NC	NC
9	SI	SLI Write		4	NC	NC
8	SO	SLI Read		5	NC	NC
7	SC	SLI CLOCK		6	NC	NC
6	GND	GND	FFC	7	GND	GND
5	GSCLK	GSCLK		8	NC	NC
4	PG	PG		9	PG	PG
3	FLT	Normal :high		10	NC	NC
3	ΓLI	Abnormal: low		10	NC	NC
2	2D/3D	ON/OFF,Low:2D,High,3D		11	2D/3D	ON/OFF,Low:2D,High,3D
1	VSYNC	VSYNC		12	VSYNC	VSYNC

Note:

If the customer's converter without the use of SLI, PG pin must be pull high(high=3.3V), PG timing is synchronization with the backlight enable signal.

4.2 Block Diagram of Interface



Attention:

- (1) This open cell uses a 100 ohms (Ω) resistor between positive and negative lines of each receiver input.
- (2) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line respectively.

4.3 LVDS Interface

4.3.1 VESA Format (SELLVDS = H)

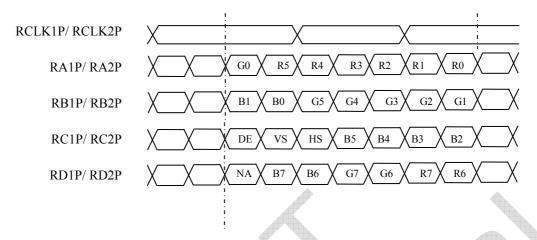


Fig. 4.2VESA format

4.3.2 JEIDA Format (SELLVDS = L or Open)

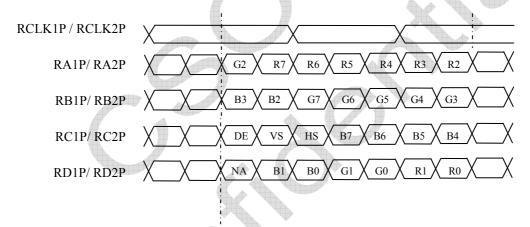
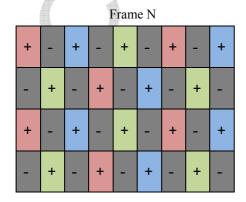
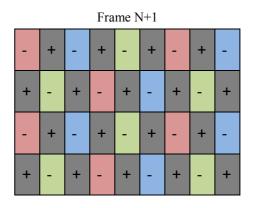


Fig. 4.3 JEIDA format

4.4 Pattern FOR Vcom Adjustment

Dot - inversion pattern





5. Interface Timing

5.1 Timing Table (DE Only Mode)

Signal	1	Item	Symbol	Min.	Тур.	Max.	Unit	Note
		Frequency	F_{CLK} (=1/ T_{CLK})	60	74.25	77	MHz	(2)
LVDS	}	Input cycle to cycle jitter	T_{rel}	I	I	200	ps	(3)
Receiver (Clock	Spread spectrum modulation range	$F_{\text{clkin_mod}}$	F _{clkin} -2%	I	F _{clkin} +2%	MHz	(4)
		Spread spectrum modulation frequency	F_{SSM}			200	KHz	
LVDS Receiver		Receiver Skew Margin	T_{RSM}	-400	-	400	ps	(5)
Eromo D	oto	2D Mode	F	47	60	62	Hz	
Frame R	ate	3D Mode	F	60	60	60	Hz	(7)
		Total	TV	1115	1125	1380	ТН	TV = TVD +TVB
	2D	Display	TVD	_	1080		TH	
Vertical		Blank	TVB	35	45	300	TH	
Term		Total	TV		1125		TH	
	3D	Display	TVD		1080		TH	(6),(8)
		Blank	TVB		45		TH	
	2D	Total	TH	1050	1100	1150	TCLK	TH = THD + THB
	2D	Display	THD		960		TCLK	
Horizontal		Blank	THB	90	140	190	TCLK	
Term	3D	Total	TH	1050	1100	1150	TCLK	TH = THD + THB
		Display	THD		960		TCLK	
		Blank	THB	90	140	190	TCLK	

Notes:

(1) The module is operated in DE only mode, H sync and V sync input signal have no effect on normal operation.

(2) Please make sure the range of pixel clock follows the following equations:

 $Fclkin(max) \ge Fmax \times Tv \times Th$ $Fmin \times Tv \times Th \ge Fclkin(min)$

 $T_{\boldsymbol{V}}$

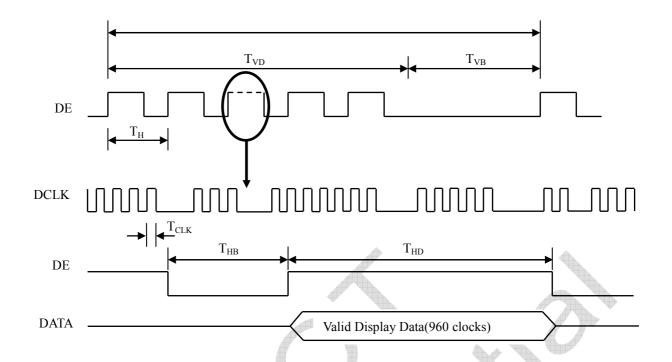


Fig. 5.1 Interface signal timing diagram

(3) The input clock cycle-to-cycle jitter is defined as the following figure. Trcl = I T1-TI

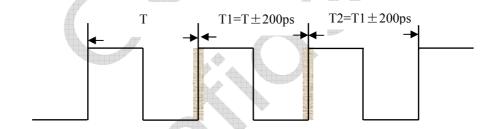
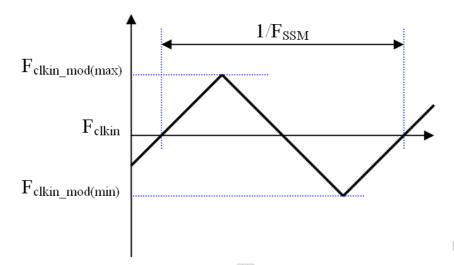


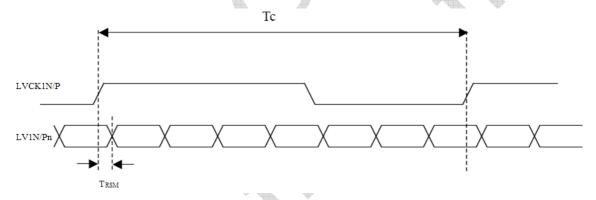
Fig. 5.2 jitter

(4) The SSCG (Spread Spectrum Clock Generator) is defined as the following figure.



(5) The LVDS timing diagram and setup/hold time is defined and showed as the following figure.

LVDS RECEIVERINTERFACE TIMING DIAGRAM



- (6) Please fix the vertical timing in 3D mode. (Vertical Total =1125/Display=1080/Blank=45)
- (7) In 3D mode, the setup F should be in Typ. In order to ensure that the eclectic function performance to avoid no display symptom.(Except picture quality symptom)
- (8) In 3D mode, the setup Tv and Tvb should be in Typ. In order to ensure that the electric function performance to avoid no display symptom. (Except picture quality symptom)

6. Optical Characteristics

6.1 Measurement Conditions

The table below is the test condition of optical measurement.

Item	Symbol	Value	Unit			
Ambient Temperature	T _A 25±2		°C			
Ambient Humidity	H_A	50±10	%RH			
Supply Voltage	V _{CC}	12	V			
Driving Signal	Refer to the typical value in Chapter 3: Electrical Specification					
Vertical Refresh Rate	F_R	120	Hz			

To avoid abrupt temperature change during optical measurement, it's suggested to warm up the LCD module more than 60 minutes after lighting the backlight and in the windless environment.

To measure the LCD cell, it is suggested to set up the standard measurement system as Fig. 6.1. The measuring area S should contain at least 500 pixels of the LCD cell as illustrated in Fig.6.2(A means the area allocated to one pixel). In this model, for example, the minimum measuring distance Z is 370mm when θ is 2 degree. Hence, 500mm is the typical measuring distance. This measuring condition is referred to 301-2H of VESA FPDM 2.0 about viewing distance, angle, and angular field of view definition.

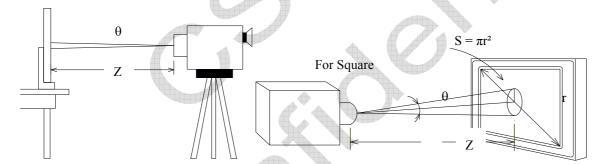


Fig. 6.1The standard set-up system of measurement

Fig. 6.2The area S contains at least 500 pixels to be measured

$$N = \frac{S}{A} \ge 500$$
 pixels

N means the actual number of the pixels in the area S.

6.2 Optical Specifications

The table below of optical characteristics is measured by MINOLTA CS2000, MINOLTA CA310, ELDIM OPTIScope-SA and ELDIM EZ Contrast in dark room.

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Static Contrast Ratio		CR		-	4000	-	-	(1)(2)
Response Time		$T_{\rm L}$		-	6.5	12	ms	(3)
Center Transmittance		Т%		-	5.65		%	(2)(4)
Color Chromaticity (CIE1931)	Red	R_{X}	θ_H =0°, θ_V =0° Normal direction at center point with CSOT's module: MT4761B01-1	Typ 0.03	0.633	Typ. +0.03	-	(2) (5)
		R_{Y}			0.334		-	
	Green	G_X			0.322		-4	
		G_{Y}			0.631		_	
	Blue	B_X			0.159			
		B_{Y}			0.049			
	White	W_X			0.280		-	
		W _Y			0.290		-	
	Color Gamut	CG		-	72	_	% NTSC	
Viewing Angle	Horizontal	θ_{H^+}			89	-	Deg. (6	(6)
		$\theta_{ ext{H-}}$	CD> 10		89	-		
	Vertical	θ_{V^+}	CR≥10		89	-		
		$\theta_{ ext{V-}}$		-	89	-		

Note:

(1)Definition of static contrast ratio (CR):

It's necessary to switch off all the dynamic and dimming function when measuring the static contrast ratio.

Static Contrast Ratio (CR) =
$$\frac{\text{CR-W}}{\text{CR-D}}$$

CR-W is the luminance measured by LMD (light-measuring device) at the center point of the LCD module with full-screen displaying white. The standard setup of measurement is illustrated in Fig. 6.3; CR-D is the luminance measured by LMD at the center point of the LCD module with full-screen displaying black. The LMD in this item is CS2000.

(2)The LMD in the item could be a spectroradiometer such as (KONICA MINOLTA) CS2000, CS1000(TOPCON), SR-UL2 or the same level spectroradiometer. Other display color analyzer (KONICA MINOLTA) CA210, CA310 or (TOPCON) BM-7 could be involved after being calibrated with a spectroradiometer on each stage of a product.

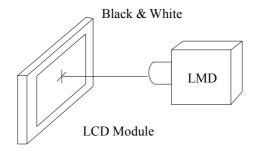


Fig. 6.3 The standard setup of CR measurement

(3) Response time T_L is defined as the average transition time in the response time matrix. The table below is the response time matrix in which each element $t_{X \text{ to } Y}$ is the transition time from luminance ratio X to Y. X and Yare two different luminance ratiosamong0%,25%,50%,75%, and 100%luminance. The transition time $t_{X \text{ to } Y}$ is defined as the time taken from 10% to 90% of the luminance difference between X and Y (X<Y) as illustrated in Fig.6.4. When X>Y, the definition of $t_{X \text{ to } Y}$ is the time taken from 90% to 10% of the luminance difference between X and Y. The response time is optimized on refresh rate F_r =60Hz.

Measured Transition Time		Luminance Ratio of Previous Frame					
		0%	25%	50%	75%	100%	
	0%		t _{25% to 0%}	t _{50% to 0%}	t _{75% to 0%}	t _{100% to 0%}	
Luminance Ratio of Current Frame	25%	t _{0% to 25%}		t _{50% to 25%}	t _{75% to 25%}	t _{100% to 25%}	
	50%	t _{0% to 50%}	t _{25% to 50%}		t _{75% to 50%}	t _{100% to 50%}	
	75%	t _{0% to 75%}	t _{25% to 75%}	t _{50% to 75%}		t _{100% to 75%}	
	100%	t _{0% to 100%}	t _{25% to 100%}	t _{50% to 100%}	t _{75% to 100%}		

 $t_{X \text{ to } Y}$ means the transition time from luminance ratio X to Y.

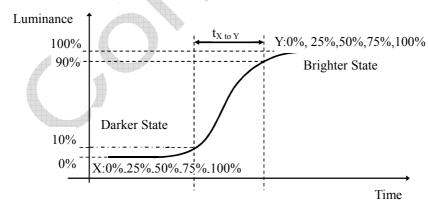


Fig. 6.4The definition of $t_{X \text{ to } Y}$

All the transition time is measured at the center point of the LCD module by ELDIM OPTIScope-SA.

(4) Definition of center Transmittance (T%):

The transmittance is measured with full white pattern (Gray 255)

(5) Definition of color chromaticity:

Each chromaticity coordinates (x, y) are measured in CIE1931 color space when full-screen displaying primary color R, G, B and white. The color gamut is defined as the fraction in percent of the area of the triangle bounded by R, G, B coordinates and the area is defined by NTSC 1953 color standard in the CIE color space. Chromaticity coordinates are measured by CS2000 and the standard setup of measurement is shown in Fig. 6.5.

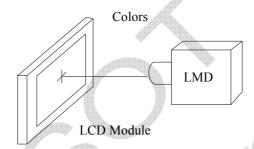


Fig. 6.5 The standard setup of color chromaticity measurement

(6)Definition of viewing angle coordinate system (θ_H, θ_V):

The contrast ratio is measured at the center point of the LCD module. The viewing angles are defined at the angle that the contrast ratio is larger than 10 at four directions relative to the perpendicular direction of the LCD module(two vertical angles :up θ_{V+} and down θ_{V-} ; and two horizontal angles: right θ_{H+} and left θ_{H-}) as illustrated in Fig. 6.6. The contrast ratio is measured by ELDIM EZContrast.

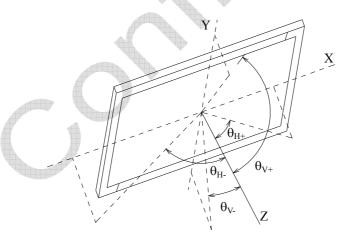
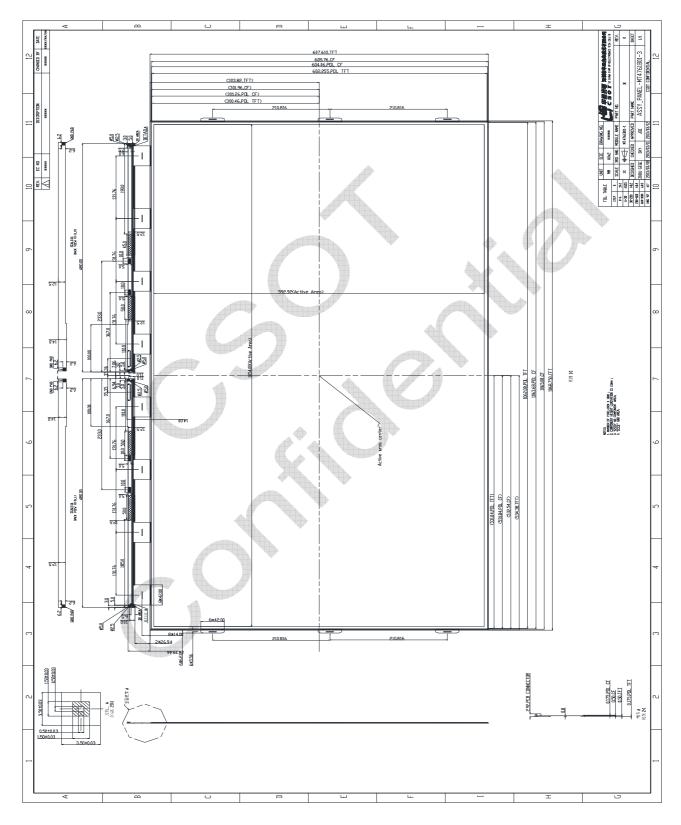


Fig. 6.6 Viewing angle coordination system

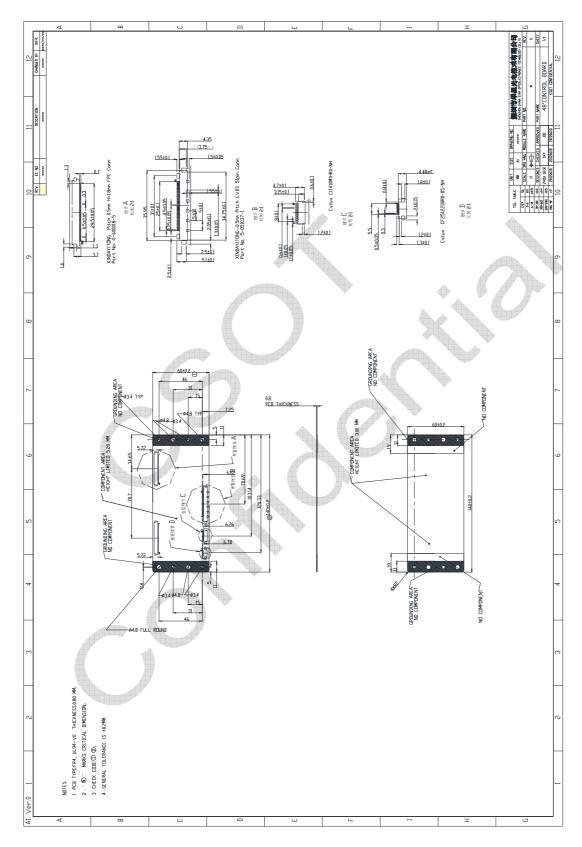
7. Mechanical Characteristics

7.1Mechanical Specification

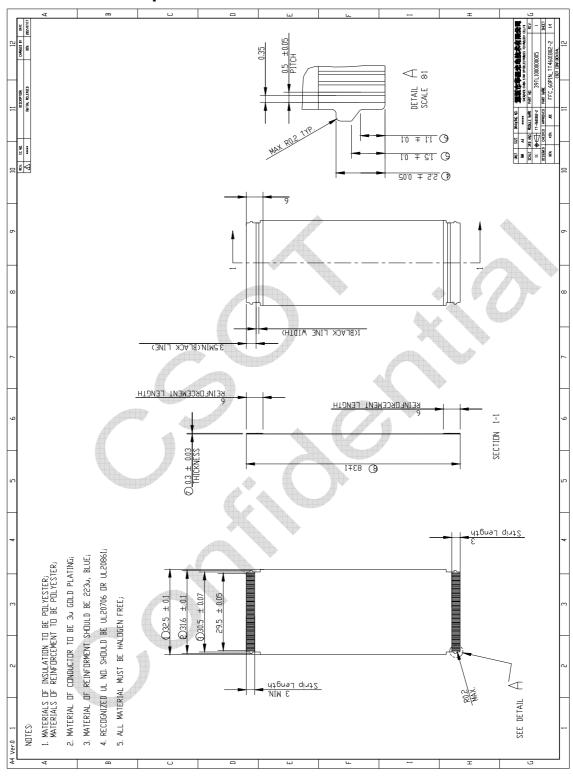
7.1.1 Open Cell Mechanical Specification



7.1.2 TCON Board Mechanical Specification



7.1.3 FFC Mechanical Specification

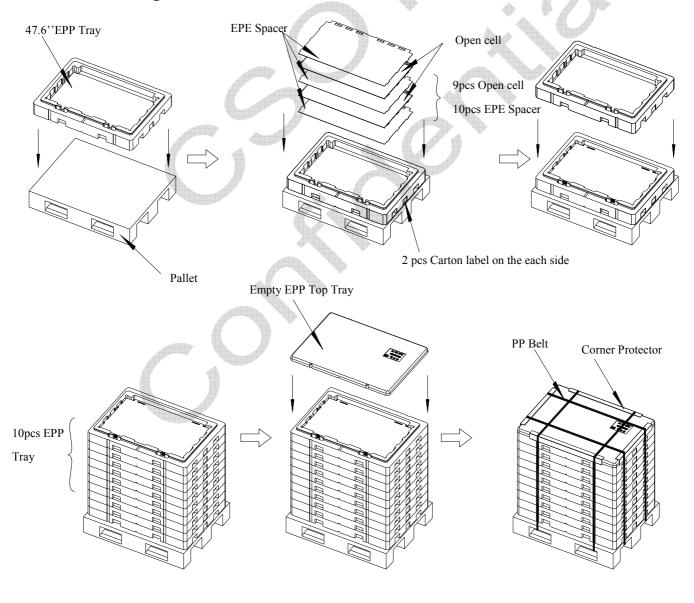


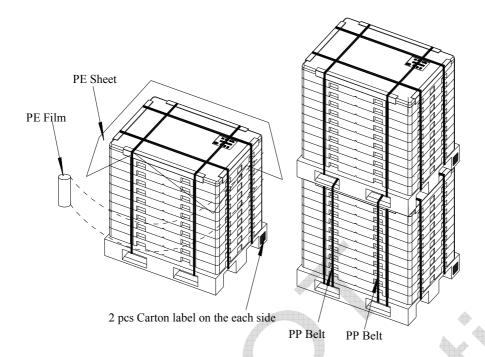
7.2 Packing

7.2.1 Packing Specifications

Itama	Specification					
Item	Quantity	Dimension (mm)	Weight (kg)			
Doolsing Day	9 pcs/box	1225/1 \ 992 (W)05 (H)	Net Weight: 18 (Max.)			
Packing Box		1235(L) x 883 (W) x95 (H)	Gross Weight: 22(Max.)			
Pallet	1	1250.00 (L) x 1000.00 (W) x 160.00 (H)	Net Weight:22			
Stack Layer	10					
Boxes per Pallet	10boxes/pallet					
Pallet after Packing	90pcs/pallet	1250.0 (L) x 1000.0 (W) x 995.0 (H)	Gross Weight:244kg/pallet			

7.2.2 Packing Method

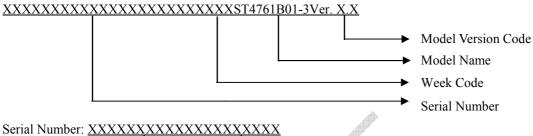


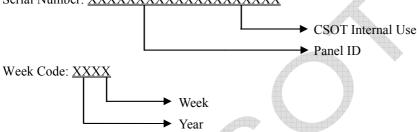


8. Definition of Labels

8.1 Open Cell Label







Year: 2010 = 10, $2011 = 11 \dots 2020 = 20$, $2021 = 21 \dots$

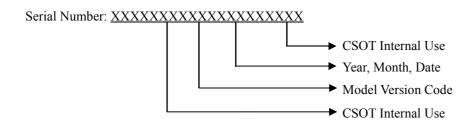
Week: 01, 02, 03 ...

Model Name: ST4761B01-3

Ver.X.X: Version, for example: 0.1, 0.2, ..., 1.1, 1.2, ..., 2.1, 2.2, ...

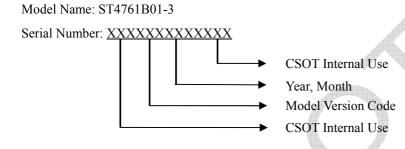
8.2 Carton Label





8.3 Pallet Label





9. Precautions

9.1 Assembly and Handling Precautions

- (1) Do not apply rough force such as bending or twisting to the open cell during assembly.
- (2) It is recommended to assemble or install a open cell into the user's system in clean working areas. The dust and oil may cause electrical shorterdamage the polarizer.
- (3) Do not apply pressure or impulse to the open cell to prevent the damage to the open cell.
- (4) Always follow the correct power-on sequence. This can prevent the damage and latch-up to the LSI chips.
- (5) Do not plug in or pull out the interface connector while the open cell is in operation.
- (6) Use soft dry clothwithout chemicals for cleaning because the surface of polarizer's very soft and easily be scratched.
- (7) Moisture can easily penetrate into the open cell and may cause the damage during operation.
- (8) High temperature or humidity may deteriorate the performance of the open cell. Please store open cell in the specified storage conditions.
- (9) When ambient temperature is lower than 10°C, the display quality might be deteriorated. For example, the response time will become slow.

9.2 Safety Precautions

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the open cell end of life, it is not harmful in case of normal operation and storage.